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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| P&ent Application Serial No | |
| illing Date | |
| Inventorship | Kunal R. Parekh et al. |
| Assignee | Micron Technology, Inc. |
| Group Art Unit | 2812 |
| | H. Jey Tsai |
| Attorney's Docket No | MI22-2260 |
| Title | Methods of Forming Memory Circuitry |

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

References - See Attached Form PTO-1449

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. Copies of the cited art are attached hereto. No admission is made regarding whether all the submitted references are prior art.

This Supplemental Information Disclosure Statement is being filed before the mailing of a first office action. Therefore, no fee is believed to be required. However, in the event that a fee is required for filing this Supplemental Information Disclosure Statement, please charge the fee specified under 37 C.F.R. § 1.17(p) to Deposit Account No. 23-0925.

Respectfully submitted,

Dated: 12 -16-03

Mark S. Matkin

Reg. No. 32,268

| Form PTO 14BE | | | U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | ATTY. DOCKET NO. MI22-2260 | | | SERIAL NO. 10/615,287 | | |
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| PATENT AND TRADEMARK OFFICE PATENT AND TRADEMARK OFFICE PATENT AND TRADEMARK OFFICE Use several sheets if necessary) | | | | | APPLICANT: Kunal R. Parekh et al. | | | | | |
| OEC 1 6 2003 (Use several sheets if necessary) | | | | FILING DATE July 7, 2003 | | | GROUP 2812 | | | |
| U.S. PATENT DOCUMENTS | | | | | | | | | | |
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| | AL | | | | | | | Yes | No | |
| | АМ | | | | | | | - | | |
| | AN | | | | | | | | | |
| OTHER RE | FERFN | CES (including Author | Title Date Pe | ertinent Pages Ftc.) | | | <u> </u> | 1 | | |
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| *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | | | | | | | | | | |